32nd IEEE International Conference on Electrical Performance of Electronic Packaging and Systems

October 15th -18th, 2023, Milpitas, CA

EPEPS is the premier international conference on advanced and emerging issues in electrical modeling, analysis, synthesis and design of electronic interconnections, packages and systems. It also focuses on new methodologies and CAD/Design/Measurement techniques for evaluating and ensuring signal, power and thermal integrity in high-speed designs. EPEPS is jointly sponsored by the IEEE Electronics Packaging Society, the IEEE Microwave Theory and Techniques Society, and the IEEE Antennas and Propagation Society.

EPEPS will be an excellent forum to highlight the latest advances in the high-speed and high performance semiconductor industry. It is expected that over 120 participants from industry and universities will engage in the 3 full day conference, to be held during Oct. 15-18, 2023 in Milpitas, CA, USA. The forum offers a great opportunity for sponsorships and for related companies to build their brands in this leading international platform. Sponsors will be given high visibility on the EPEPS web site and social media, prominent placement of their logo/info in the conference proceedings, access to the EPEPS conference technical programs and training sessions, and premium display booth locations.

Sponsorship Packages

There are three different sponsorship packages available: **Platinum, Gold, and Silver** as well as **Exhibitor opportunities**. Each level of sponsorship provides a different level of company exposure.

Package	Platinum	Gold	Silver	Exhibitor
Sponsorship Amount	$10000	$6000	$3000	$2000
Max # of Sponsors	2	5	10	NA
Hosting Recognition	Social Event	Lunch Breaks	Coffee Breaks	x
Web Exposure	Prime	✓	✓	
Social Media Exposure	✓	✓	✓	✓
Conference Proceedings	2 pages	1 page	½ page	Name & logo
Complimentary Registration	4	2	1	1
Discounted ($450) Registration	4	3	2	1
Conference Package	✓	✓	✓	x
CAD Training Program	1 hr	1 hr	x	x
Exhibition Opportunity	✓	✓	✓	✓
Student Recruiting Event	✓	✓	✓	x
Product Demo/Presentation	20 mins	15 mins	10 mins	x
Special Thanks	✓	✓	x	x
Display Cards	✓	✓	✓	x

Notes:

- **Hosting Recognition:** You will be recognized as a Platinum/Gold/Silver Sponsor of the conference as well as a sponsor of the Conference Social Event based on your sponsorship level.
- **PRIME Web Exposure**: Your company logo and a link to your company's website will be prominently featured at www.epeps.org until May 2023.
- **Social Media Exposure:** Your company will be promoted by EPEPS LinkedIn group.
- **Conference Proceedings and Electronic Media:** Exclusive material (length depends on the sponsorship level) will be provided in the proceedings to highlight your company and its products.
- **Complimentary Registrations:** Complimentary conference registrations will be provided.
- **Conference Package:** Every conference package will include an insert supplied by your company, offering an opportunity for lasting company exposure. Also, the opportunity may be available to provide delegate badge lanyards and/or conference bags with your company logo.
- **CAD Training Program:** Your company will have a presentation opportunity to demonstrate product features or technical tutorial in Sunday training session for EPEPS attendees.
- **Exhibition Opportunities:** You will be provided with an individual booth to exhibit new company technology and research at a prime location in the exhibit area. Company name and logo will also be listed under the exhibitors section in the conference proceedings.
- **Student Recruiting Event:** A student recruiting event will be held at the conference. Your company can use an assigned booth to maximize your exposure to students during the event.
- **Product Presentation/Demo:** Opportunity to show live demo or product presentation for allotted time (depending on the sponsorship level) to technical session attendees at the end of the technical sessions.
- **Special Thanks:** A formal thank you will be made at the welcome address.
- **Display Cards:** ponsor information will be prominently displayed in the conference site.